

12500 TI Boulevard, MS 8640, Dallas, Texas 75243

PCN# 20180510000.1 Qualification of MIHO8 as an additional Wafer Fab Site option for select devices Change Notification / Sample Request

Date: May 15, 2018

To: PREMIER FARNELL PCN

Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

We request you acknowledge receipt of this notification within **30** days of the date of this notice. Lack of acknowledgement of this notice within 30 days constitutes acceptance of the change. If you require samples or additional data to support your evaluation, please request within 30 days.

The changes discussed within this PCN will not take effect any earlier than **90** days from the date of this notification, unless customer agreement has been reached on an earlier implementation of the change. This notification period is per TI's standard process.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (PCN www admin team@list.ti.com).

PCN Team SC Business Services

20180510000.1 Attachment: 1

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
ISO7710DW	null
ISO7710FDW	null
ISO7720DWR	null
ISO7720FDWR	null
ISO7721DW	null
ISO7721FDW	null
ISO7730DBQ	null
ISO7730DWR	null
ISO7730FDBQ	null
ISO7730FDWR	null
ISO7731DBQ	null
ISO7731DWR	null
ISO7731FDBQ	null
ISO7731FDWR	null
ISO7740DBQ	null
ISO7740DWR	null
ISO7740FDBQ	null
ISO7740FDWR	null
ISO7741DBQ	null
ISO7741DW	null
ISO7741FDBQ	null
ISO7741FDW	null
ISO7742DWR	null
ISO7742FDWR	null

Technical details of this Product Change follow on the next page(s).

PCN Number: 20180510000.1 May 15, 2018 PCN Date: Qualification of MIHO8 as an additional Wafer Fab Site option for select devices in Title: LBC8LV Technology **Customer Contact: PCN Manager** Dept: **Quality Services Estimated Sample** Date provided at sample **Proposed 1st Ship Date:** Aug 15, 2018 **Availability:** request. **Change Type:** Assembly Site **Assembly Process Assembly Materials Electrical Specification Mechanical Specification** Design **Test Site** Packing/Shipping/Labeling Test Process Wafer Bump Process Wafer Bump Site Wafer Bump Material Wafer Fab Site Wafer Fab Materials Wafer Fab Process Part number change

PCN Details

Description of Change:

Texas Instruments is pleased to announce the qualification of its MIHO8 fabrication facility as an additional Wafer Fab source for the selected devices listed in "Product Affected" section.

Current Sites		Additional Sites			
Current Fab Site	Process	Wafer Diameter	Additional Fab Site	Process	Wafer Diameter
DP1DM5	LBC8LV	200mm	MIHO8	LBC8LV	200mm

Qual details are provided in the Qual Data Section.

Reason for Change:

Continuity of Supply

Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):

Changes to product identification resulting from this PCN:

Current

Chip Site	Chip Site Origin (20L)	Chip Site Country Code (21L)	Chip Site City
DP1DM5	DM5	USA	Dallas

New Fab Site

Chip Site	Chip Site Origin (20L)	Chip Site Country Code (21L)	Chip Site City
MIHO8	MH8	JPN	Ibaraki

Sample product shipping label (not actual product label)







Product Affected:			
ISO7710D	IS07721DR	ISO7731DBQ	ISO7741DBQR
ISO7710DR	IS07721DW	ISO7731DBQR	ISO7741DW
ISO7710DW	ISO7721DWR	ISO7731DW	ISO7741DWR
ISO7710DWR	ISO7721FBDW	ISO7731DWR	ISO7741FBDW
ISO7710FD	ISO7721FBDWR	ISO7731FBDW	ISO7741FBDWR
ISO7710FDR	IS07721FD	ISO7731FBDWR	ISO7741FDBQ
ISO7710FDW	ISO7721FDR	ISO7731FDBQ	ISO7741FDBQR
ISO7710FDWR	ISO7721FDW	ISO7731FDBQR	ISO7741FDW
ISO7720D	ISO7721FDWR	ISO7731FDW	ISO7741FDWR
ISO7720DR	ISO7730DBQ	ISO7731FDWR	ISO7742DBQ
ISO7720DW	ISO7730DBQR	ISO7740DBQ	ISO7742DBQR
ISO7720DWR	ISO7730DW	ISO7740DBQR	ISO7742DW
ISO7720FD	ISO7730DWR	ISO7740DW	ISO7742DWR
ISO7720FDR	ISO7730FDBQ	ISO7740DWR	ISO7742FDBQ
ISO7720FDW	ISO7730FDBQR	ISO7740FDBQ	ISO7742FDBQR
ISO7720FDWR	ISO7730FDW	ISO7740FDBQR	ISO7742FDW
ISO7721BDW	ISO7730FDWR	ISO7740FDW	ISO7742FDWR
ISO7721BDWR	ISO7731BDW	ISO7740FDWR	
ISO7721D	ISO7731BDWR	ISO7741DBQ	

Qualification Report

LBC8LVISO in Miho8 Approve Date 28-Jun-2017

Product Attributes

Attributes	Qual Device: ISO7741FQDWQ1
Assembly Site	TAI
Package Family	SOIC
Flammability Rating	UL 94 V-0
Wafer Fab Supplier	MIHO8
Wafer Fab Process	LBC8LVISO

- QBS: Qual By Similarity
- Qual Device ISO7741FQDWQ1 is qualified at LEVEL2-260C
- Device ISO7741FQDWQ1 contains multiple dies.

Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: ISO7741FQDWQ1
AC	Autoclave 121C	96 Hours	3/231/0
ELFR	Early Life Failure Rate, 125C	48 Hours	3/2600/0
HAST	Biased HAST, 130C/85%RH	96 Hours	3/231/0
HTOL	Life Test, 125C	1000 Hours	3/231/0
HTSL	High Temp Storage Bake 175C	500 Hours	3/231/0
TC	Temperature Cycle, -65/150C	500 Cycles	3/230/0
WBP	Bond Pull	Wires	3/228/0
WBS	Wire Bond Shear	Wires	3/228/0

⁻ Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

- The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
- The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours
- The following are equivalent Temp Cycle options per JESD47: -55C/125C/700 Cycles and -65C/150C/500 Cycles Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free (SMT) and Green

For questions regarding this notice, e-mails can be sent to the regional contacts shown below, or you can contact your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com